



PRELIMINARY SPEC

Features

- 2.0mmx1.25mm SMT LED,1.1mm thickness.
- Low power consumption.
- Wide viewing angle.
- Ideal for backlight and indicator.
- Various colors and lens types available.
- Package : 2000pcs / reel.
- Moisture sensitivity level : level 3.
- RoHS compliant.

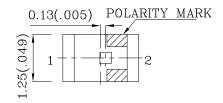


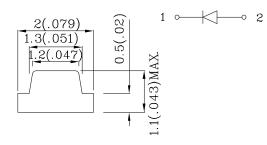


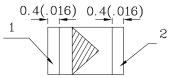
Notes:

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is $\pm 0.1(0.004")$ unless otherwise noted.
- 3. Specifications are subject to change without notice.

Absolute Maximum Rating (TA=25°C)	M2ACY (AlInGaP)	Unit			
Reverse Voltage	$V_{\rm R}$	5	V		
Forward Current	IF	30	mA		
Forward Current (Peak) 1/10 Duty Cycle 0.1ms Pulse Width	ifs	140	mA		
Power Dissipation	Рт	75	mW		
Operating Temperature	TA	-40 ~ +85	°C		
Storage Temperature	Tstg	-40 ~ +85	-0		

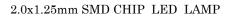




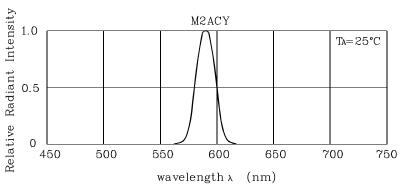


Operating Characteristic (TA=25°C)	M2ACY (AlInGaP)	Unit	
Forward Voltage (Typ.) (IF=20mA)	VF	2.0	V
Forward Voltage (Max.) (IF=20mA)	VF	2.5	V
Reverse Current (Max.) (V _R =5V)	IR	10	uA
Wavelength of Peak Emission (Typ.) (IF=20mA)	λΡ	590	nm
Wavelength of Dominant Emission (Typ.) (IF=20mA)	λ D	589	nm
Spectral Line Full Width At Half-Maximum (Typ.) (IF=20mA)	Δλ	20	nm
Capacitance (Typ.) (VF=0V, f=1MHz)	С	45	pF

Part Number	Emitting Color	Emitting Material	Lens-color	Luminous Intensity (IF=20mA) mcd		Wavelength nm λ P	Viewing Angle 2 0 1/2
				min.	typ.		
XZM2ACY54W	Yellow	AlInGaP	Water Clear	110	297	590	120°
Published Date : JA	AN 09,2009	Drawin	g No : XDSB2791	V1	Chec	cked : B.L.LIU	P.1/4

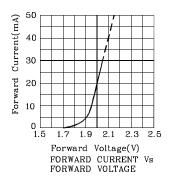


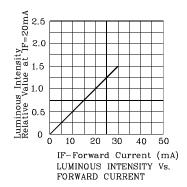


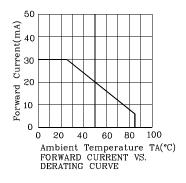


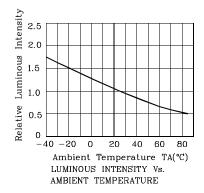
RELATIVE INTENSITY Vs. WAVELENGTH

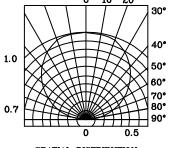
❖ M2ACY











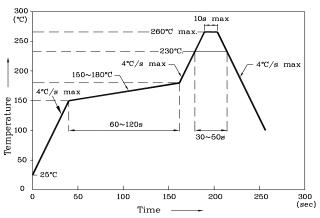
SPATIAL DISTRIBUTION



2.0x1.25mm SMD CHIP LED LAMP

Reflow soldering is recommended and the soldering profile is shown below. Other soldering methods are not recommended as they might cause damage to the product.

Reflow Soldering Profile For Lead-free SMT Process.

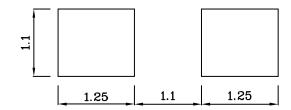


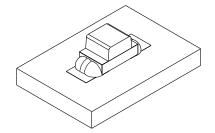
Notes:

- 1. Maximum soldering temperature should not exceed 260°C.
- 2.Recommended reflow temperature: 145°c-260°C.
- 3.Do not put stress to the epoxy resin during high temperatures conditions.

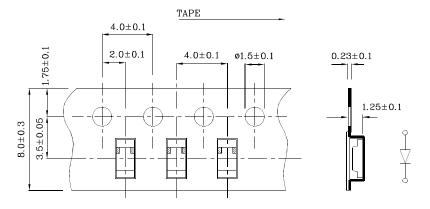
❖ Recommended Soldering Pattern (Units: mm; Tolerance: ± 0.1)

❖ The device has a single mounting surface. The device must be mounted according to the specifications.





❖ Tape Specification (Units:mm)



Remarks:

If special sorting is required (e.g. binning based on forward voltage, Luminous intensity / luminous flux, or wavelength), the typical accuracy of the sorting process is as follows:

- 1. Wavelength: +/-1nm
- 2. Luminous intensity / luminous flux: +/-15%
- 3. Forward Voltage: +/-0.1V

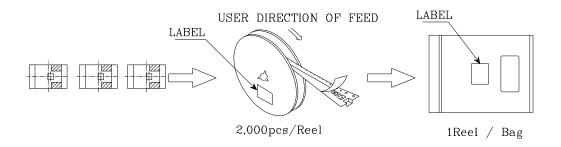
Note: Accuracy may depend on the sorting parameters.

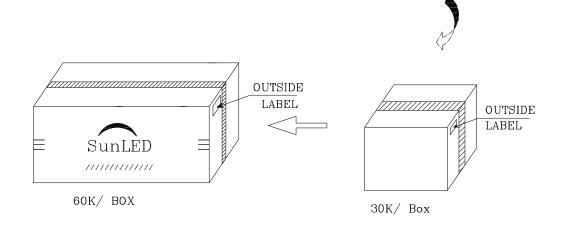


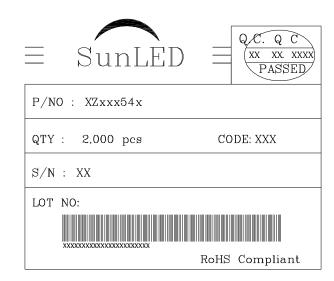


PACKING & LABEL SPECIFICATIONS

XZM2ACY54W







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